microSpire

DESIGN SPECIFICATION DATA

Sales Engineer :
Reference :
Date :

Company Name : **Contact :**

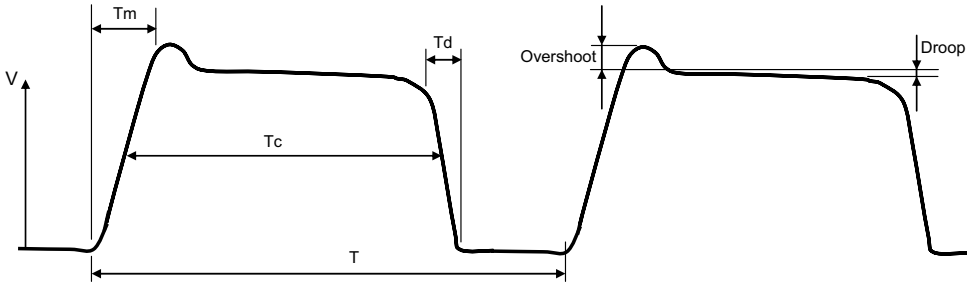
Product PT-NR : **Project :** **Yearly Quantities :**

PULSE TRANSFORMERS

Market : ☐ AIRSPACE ☐ AVIONICS / DEFENCE ☐ RAILWAY SYSTEMS
☐ Other : ☐ TELECOM ☐ INDUSTRY ☐ AUTOMOTIVE ☐ CONSUMER

Environment : Vibrations and/or shocks : Acceleration :
Humidity : Operating T° : Min/Max Storage T° : Min/Max

Applied Standards :



Tc (conduction time – lower frequency) : **Tm** (rising time) :
Td (falling time – higher frequency) : **T** (period) :

Prim. Voltage : **Sec. Voltage :** **Max. Overshoot :**

Prim. Current : **Sec. Current :** **Max. Droop :**

Secondary Load Impedance : **Source Impedance :**

Prim. / Sec. Shield : **Prim. / Sec. Isolation :**

Maximum Dimensions : Length : Width : Height :

Report Mode : ☐ SMD ☐ THROUGH-HOLE ☐ WIRE ☐ Other :

Finish : ☐ Box ☐ Gravity molding ☐ Transfer molding ☐ Coating
☐ None ☐ Dip impregnation ☐ Vacuum impregnation ☐ Injection

Marking : **Sticker on Packing :**

Packing : ☐ LOOSE ☐ STICK ☐ REEL ☐ TRAY ☐ UNITARY

MECHANICAL DRAWING

LAYOUT

Please return by fax this completely filled document at : +33.3.82.51.00.49